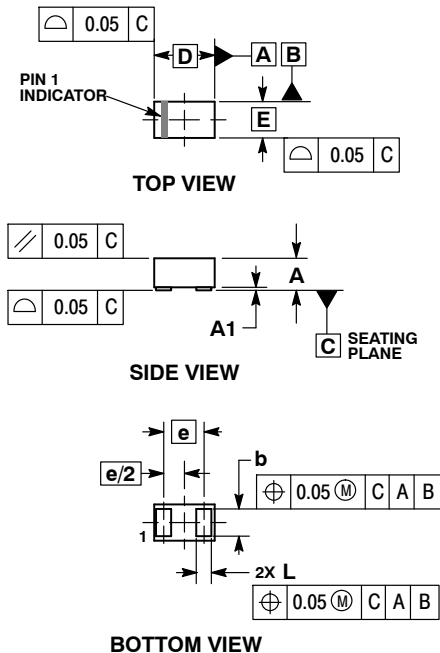




SCALE 8:1

DSN2, 1.0x0.6, 0.65P, (0402)
CASE 152AE
ISSUE A

DATE 03 JUN 2016

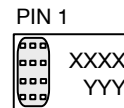


NOTES:

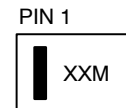
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.

MILLIMETERS		
DIM	MIN	MAX
A	0.25	0.31
A1	---	0.05
b	0.45	0.55
D	1.00 BSC	
E	0.60 BSC	
e	0.65 BSC	
L	0.20	0.30

GENERIC MARKING DIAGRAM1*



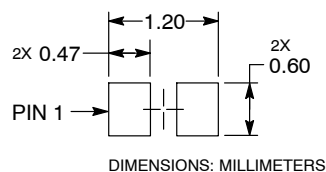
GENERIC MARKING DIAGRAM2*



XXXX = Specific Device Code XX = Specific Device Code
YYY = Year Code M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

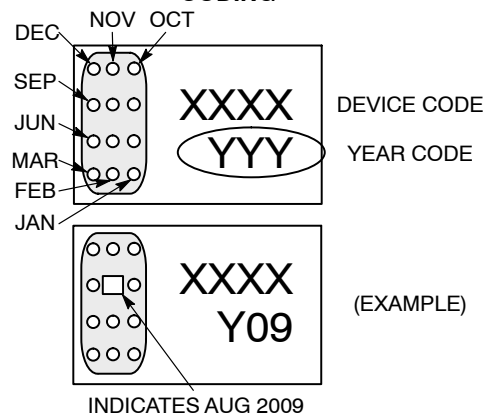
RECOMMENDED SOLDER FOOTPRINT*



See Application Note [AND8398/D](#) for more mounting details

*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, [SOLDERRM/D](#).

CATHODE BAND MONTH CODING



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DESCRIPTION:	DSN2, 1.0X0.6, 0.65P, (0402)	PAGE 1 OF 1

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